



General Description

The WSF70N10 is the highest performance trench N-Ch MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSF70N10 meet the RoHS and Green Product requirement,100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

Product Summery

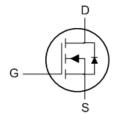
BV _{DSS}	R _{DSON}	I _D		
100V	10mΩ	70A		

Applications

- Power Management in TV Converter.
- DC-DC Converter
- LED TV Back Light

TO-252 Pin Configuration





Absolute Maximum Ratings

Symbol	Parameter	Rating	Units	
V_{DS}	Drain-Source Voltage	100	V	
V_{GS}	Gate-Source Voltage	±25	V	
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	70	Α	
I _D @T _C =100℃	Continuous Drain Current, V _{GS} @ 10V ¹	35	Α	
I _D @T _A =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	8.2	Α	
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ 10V ¹	6.6	Α	
I _{DM}	Pulsed Drain Current ^{2,} T _C =25°C	150	Α	
EAS	Avalanche Energy, Single pulse,L=0.5mH	169	mJ	
I _{AS}	Avalanche Current, Single pulse,L=0.5mH	26	Α	
P _D @T _C =25℃	Total Power Dissipation⁴	113	W	
P _D @T _C =100°C	Total Power Dissipation⁴	45	W	
T _{STG}	Storage Temperature Range	-55 to 150	℃	
T_J	Operating Junction Temperature Range	150	$^{\circ}$	

Thermal Data

Symbol	Parameter		Max.	Unit
$R_{ heta JA}$	Thermal Resistance Junction-Ambient ¹		50	°C/W
R _{0JC}	Thermal Resistance Junction-Case ¹		1.1	°C/W



Electrical Characteristics (T_J=25 C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	100			V	
$\triangle BV_{DSS}/\triangle T_{J}$	BV _{DSS} Temperature Coefficient	Reference to 25°C , I _D =1mA		0.096		V/℃	
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =30A		10	13	mΩ	
$V_{GS(th)}$	Gate Threshold Voltage	\/ -\/ -250A	2.0	3.0	4.0	V	
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$V_{GS}=V_{DS}$, $I_D=250uA$		-5.5		mV/℃	
	Drain Source Leakage Current	V_{DS} =80V , V_{GS} =0V , T_{J} =25 $^{\circ}$ C			1		
I _{DSS}	Drain-Source Leakage Current	V_{DS} =80V , V_{GS} =0V , T_{J} =55 $^{\circ}$ C			5	uA	
I _{GSS}	Gate-Source Leakage Current	V_{GS} = $\pm 20 V$, V_{DS} = $0 V$			±100	nA	
gfs	Forward Transconductance	V _{DS} =5V , I _D =30A		27		S	
R_g	Gate Resistance	V_{DS} =0V , V_{GS} =0V , f=1MHz		1.0	1.8	Ω	
Q_g	Total Gate Charge (10V)			42			
Q_gs	Gate-Source Charge	V _{DS} =80V , V _{GS} =10V , I _D =30A		12		nC	
Q_{gd}	Gate-Drain Charge			12			
T _{d(on)}	Turn-On Delay Time			19			
Tr	Rise Time	V_{DD} =50V , V_{GS} =10V , R_{G} =3 Ω ,		9			
$T_{d(off)}$	Turn-Off Delay Time	I _D =1A		36		ns	
T _f	Fall Time			22			
C _{iss}	Input Capacitance			2100			
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		255		pF	
C _{rss}	Reverse Transfer Capacitance			100			

Guaranteed Avalanche Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy ⁵	V _{DD} =25V , L=0.5mH , I _{AS} =26A	150			mJ

Diode Characteristics

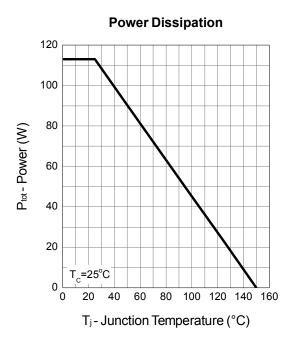
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,6}	V =V =0V Force Current			30	Α
I _{SM}	Pulsed Source Current ^{2,6}	V _G =V _D =0V , Force Current			60	Α
V_{SD}	Diode Forward Voltage ² V _{GS} =0V , I _S =15A , T _J =25℃				1.3	V
t _{rr}	Reverse Recovery Time	I= 450 dI/dt 4000 / T 05°C		42		nS
Qrr	Reverse Recovery Charge	IF=15A,dI/dt=100A/µs,T _J =25℃		90		nC

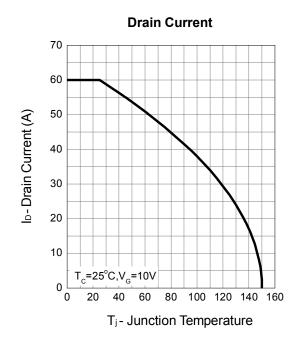
Note:

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t<10sec.
- 2.The data tested by pulsed , pulse width $\,\leq\,300\text{us}$, duty cycle $\,\leq\,2\%$
- 3. The EAS data shows Max. rating . The test condition is V_{DS} =25V, V_{GS} =10V,L=0.5mH,I_{AS}=26A
- 4.The power dissipation is limited by 150 $^{\circ}\mathrm{C}\,$ junction temperature
- 5. The Min. value is 100% EAS tested guarantee.
- 6.The data is theoretically the same as I_D and I_{DM}, in real applications, should be limited by total power dissipation.

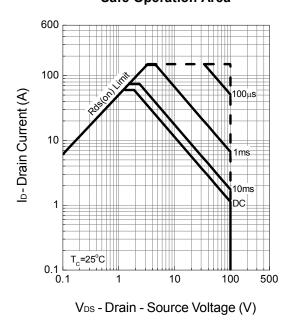


Typical Operating Characteristics

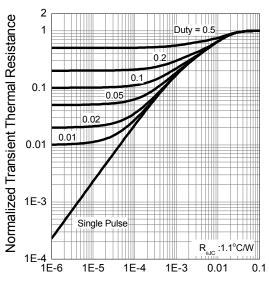




Safe Operation Area



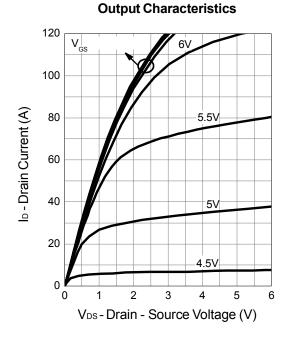
Thermal Transient Impedance



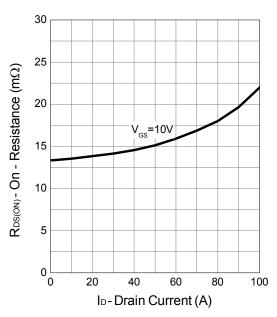
Square Wave Pulse Duration (sec)



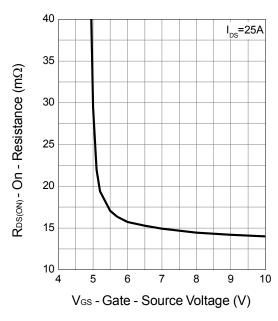
Typical Operating Characteristics (Cont.)



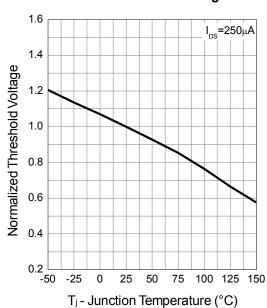
Drain-Source On Resistance



Gate-Source On Resistance



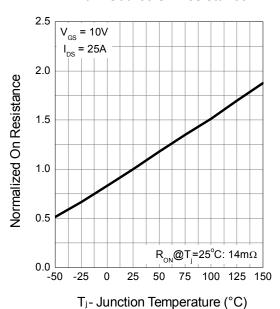
Gate Threshold Voltage



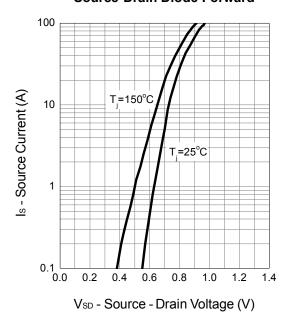


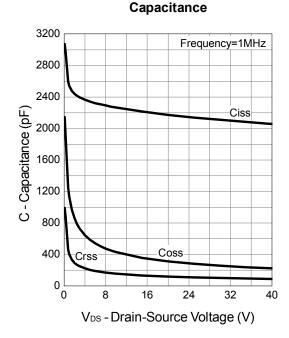
Typical Operating Characteristics (Cont.)

Drain-Source On Resistance

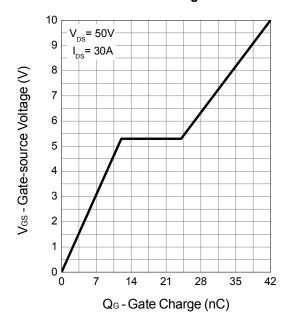


Source-Drain Diode Forward



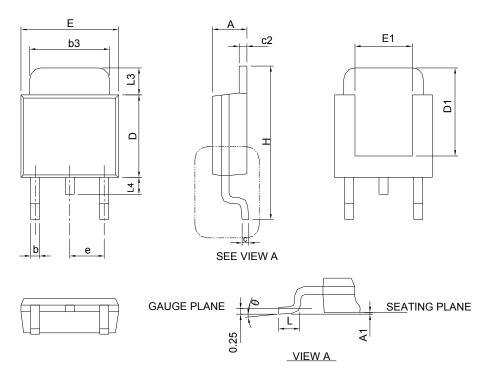


Gate Charge



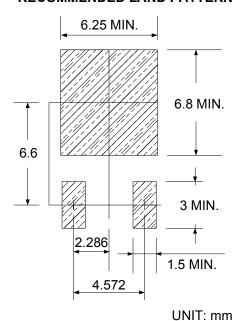


Package Information: TO-252



Ş	TO-252					
SYZEO_	MILLIMETERS		INC	HES		
Ь	MIN.	MAX.	MIN.	MAX.		
Α	2.18	2.39	0.086	0.094		
A1	-	0.13	-	0.005		
b	0.50	0.89	0.020	0.035		
b3	4.95	5.46	0.195	0.215		
С	0.46	0.61	0.018	0.024		
c2	0.46	0.89	0.018	0.035		
D	5.33	6.22	0.210	0.245		
D1	4.57	6.00	0.180	0.236		
Е	6.35	6.73	0.250	0.265		
E1	3.81	6.00	0.150	0.236		
е	2.29 BSC		0.090 BSC			
Н	9.40	10.41	0.370	0.410		
L	0.90	1.78	0.035	0.070		
L3	0.89	2.03	0.035	0.080		
L4	-	1.02	-	0.040		
θ	0°	8°	0°	8°		

RECOMMENDED LAND PATTERN





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